



RFID/NFC COIL ANT, SMT, 13.56MHz

Part Number: L000641-01

L000641-01 is an SMT mount NFC (Near Field Communications) antenna designed for high-performance two-way read/write operations at 13.56MHz.

One of the smallest NFC antennas on the market, that takes only 20% of the PCB size compared with antennas routed on the PCB, but still performing about 35mm as reading distance. The unique size and SMT mounting makes this antenna the perfect choice for space-constrained applications.

FEATURES & BENEFITS

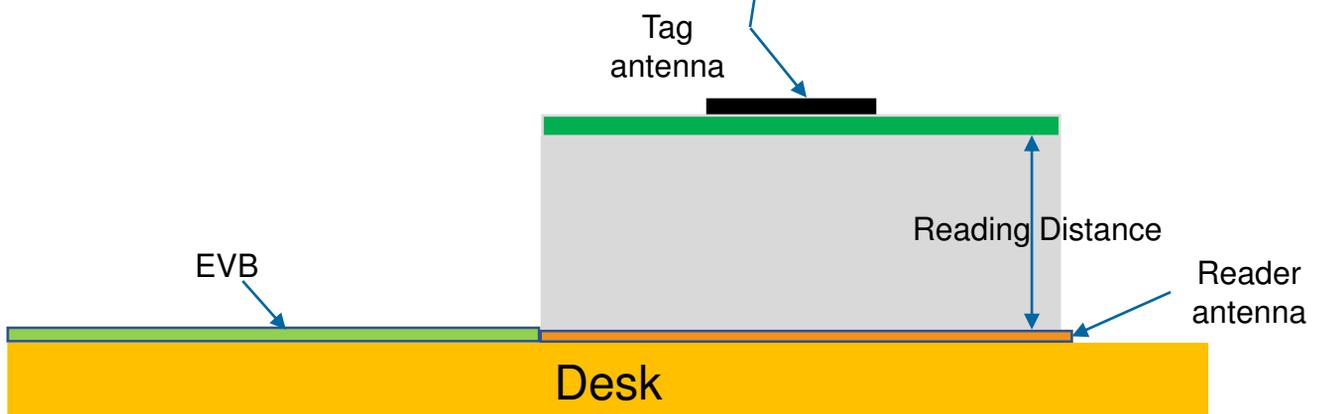
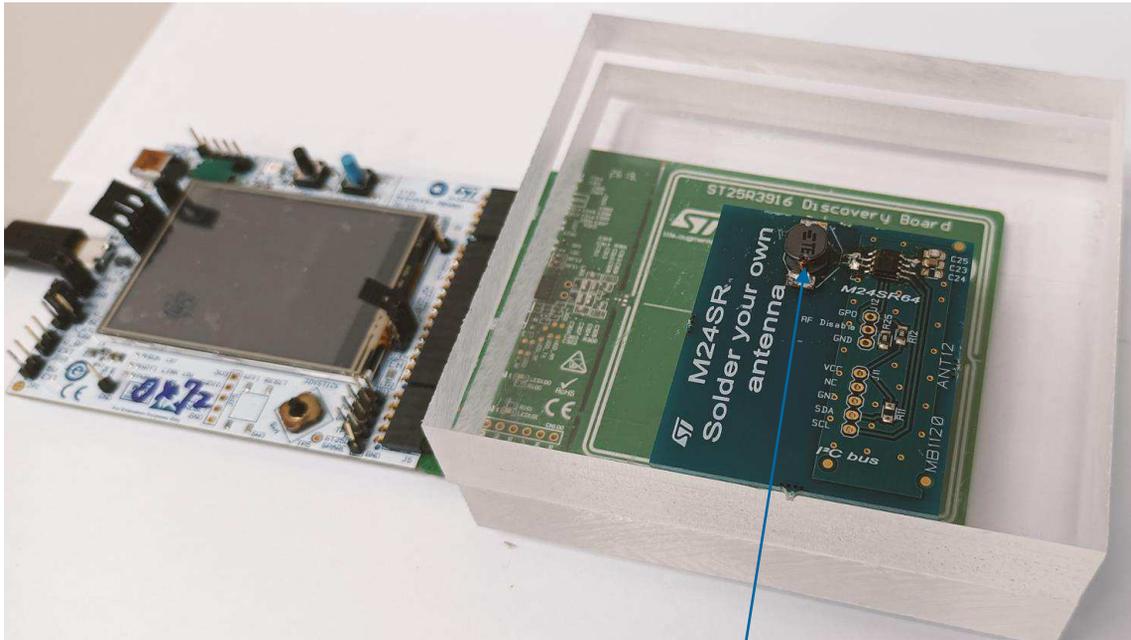
- Frequency **13.56MHz**
- Universal antenna module assembly
- Antenna type - Coil on ferrite core for increased performance
- Higher reading distance than competition
- Fully Pick & Place and SMT capable

SPECIFICATIONS

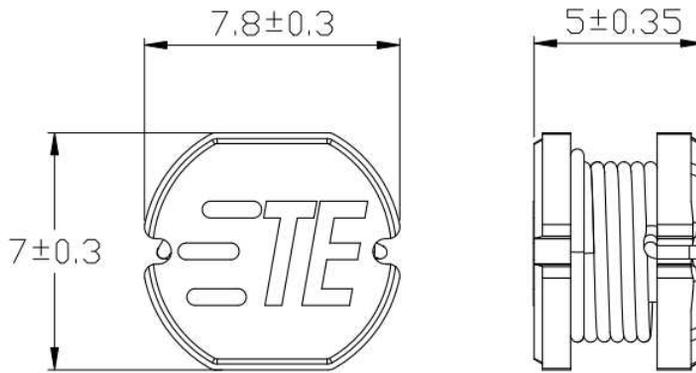
Frequency Range	13.56 MHz
Self inductance (La)	4.7 uH
DCR	0.25 Ohm
Read Distance	35 mm
Size	7.8 mm x 7 mm x 5 mm
Weight	0.85g
Mounting	Surface mount
Operating Temperature	-40 to +85°C
Storage Temperature	-40 to +85°C
Hazardous Materials	A certificate of conformance is available from the product page on TE website.

TEST SETUP

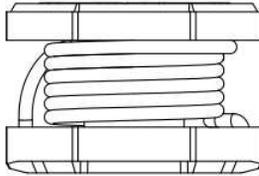
EVB MB1414 board



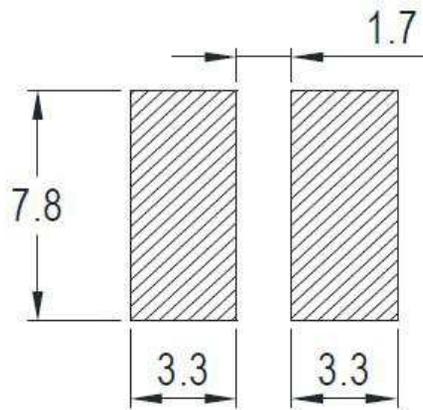
DIMENSIONS



top view



FOOTPRINT



✘ Marking shall be start from electrode side.
Marking color : Black

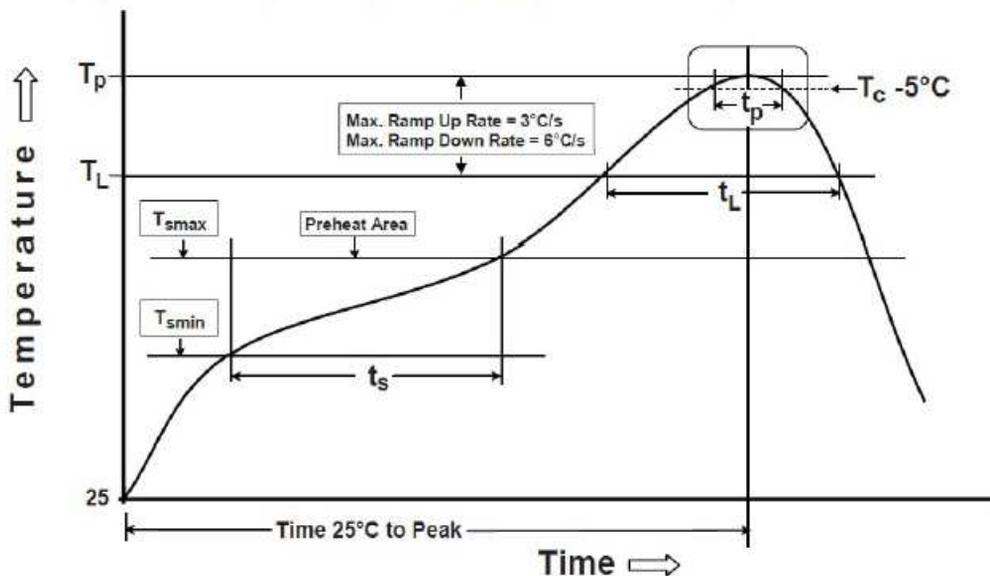
Dimensions: mm
Diagram is not to scale

REFLOW SOLDERING TEMPERATURE

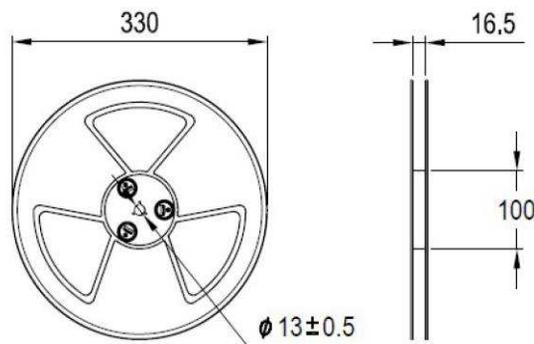
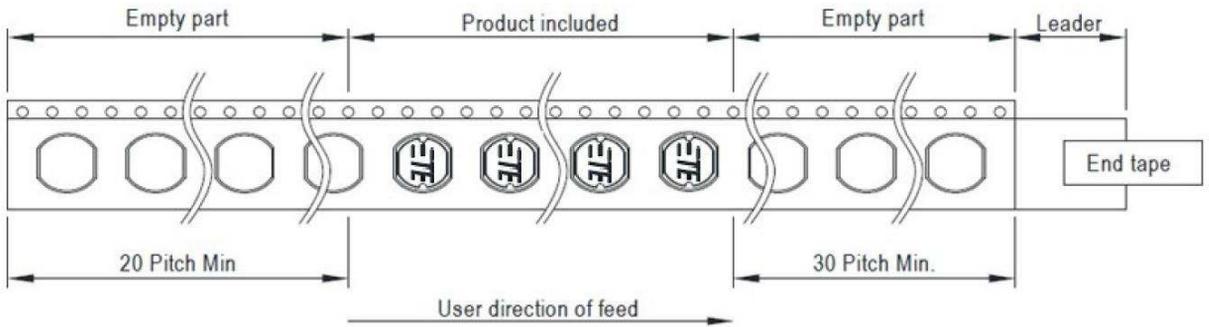
Phase	Profile Features	Pb-Free Assembly (SnAgCu)
PREHEAT	<ul style="list-style-type: none"> - Temperature Min (T_{smin}) - Temperature Max (T_{smax}) - Time (T_s) from (T_{smin} to T_{smax}) 	150°C 200°C 60-120 seconds
RAMP-UP	Avg. Ramp-Up Rate (T _{smax} to T _P)	3°C / second (max)
REFLOW	<ul style="list-style-type: none"> - Temperature (T_L) - Total Time above T_L (t_L) 	217°C 60-150 seconds
PEAK	<ul style="list-style-type: none"> - Temperature (T_P) - Time (t_p) 	260°C 20-30 seconds
RAMP-DOWN	Rate	6°C / second max
Time from 25°C to Peak Temperature		8 minutes max
Composition of solder paste		96.5Sn/3Ag/0.5Cu
Solder paste model		SHENMAO PF606-P26

Note: All temperature measure points are on the top surface of the component, if the temperature exceeds recommended levels, it can cause damage to the component or the surface to peel.

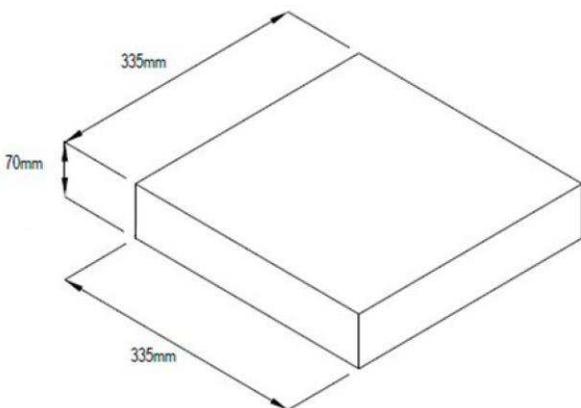
The graphic shows temperature profile for component assembly process in reflow ovens



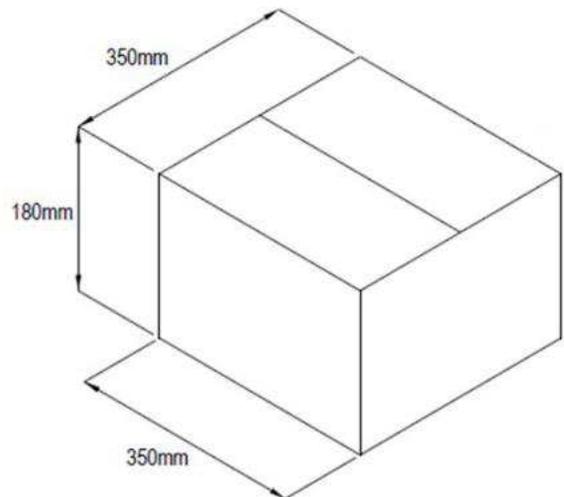
PACKAGING



*Tape and reel packing with plastic bag.
*1000 pcs/ Reel



2 reels in one inner box = 2000 pcs



2 inner boxes in one outer box = 4000 pcs

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